晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR
LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	**AO-12864RFI-00H**
APPROVED BY	
DATE	

☑ **Approved For Specifications**
☐ Approved For Specifications & Sample

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RECORD OF REVISION

Revision Date	Contents	Editor
2004/3/19	New Release	Kokai

1 FEATURES

(1) Display format : 128×64 dots, 1/64 duty, 1/9 bias.

(2) Construction : LCD panel , COG and FPC.

(3) Display type : FSTN, Transflective, Positive, 6 o'clock view

(4) Controller : ST7565S

(5) Extend temperature type.

2 MECHANICAL DATA

Parameter	Stand Value	Unit
Dot size	0.2(W) × 0.2(H)	mm
Dot pitch	0.22(W) × 0.22(H)	mm
Active area	28.14(W) ×14.06 (H)	mm
Viewing area	31.0 (W) ×16.5 (H)	mm
Module size	44.0(W) × 43.5(H) × 2.6 Max(T)	mm

3 ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Logic Circuit Supply Voltage	VDD-VSS	-0.3	+5.0	V
LCD Driving Voltage	VLCD	-16	+0.3	V
Input Voltage	VI	-0.3	VDD+0.3	V
Operating Temp.	TOP	-20	70	°C
Storage Temp.	TSTG	-30	80	°C

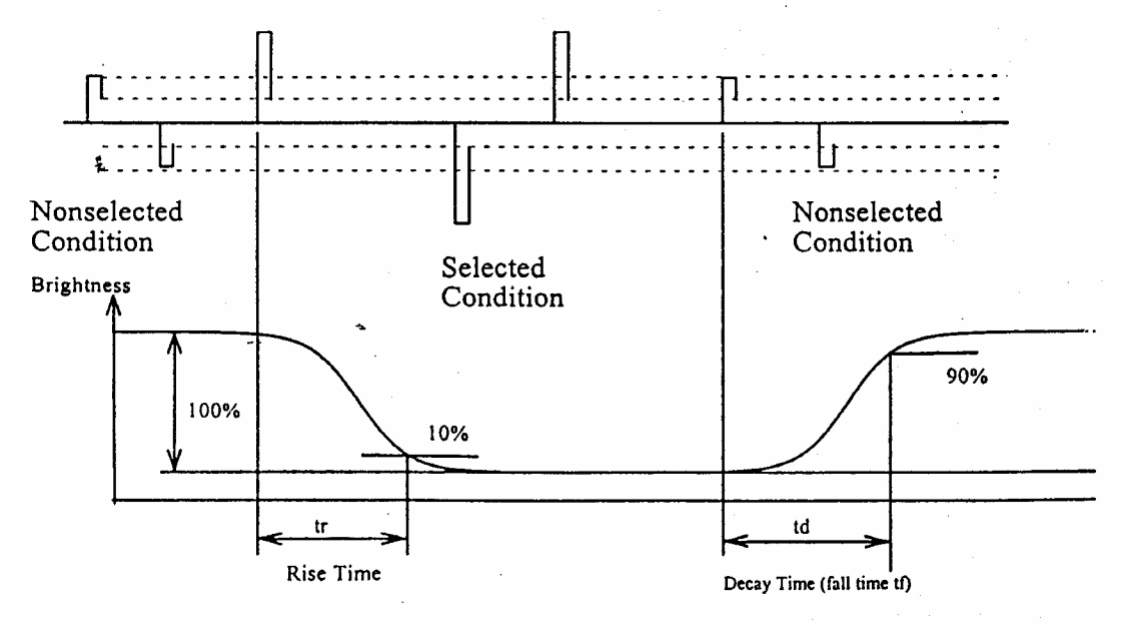
4 ELECTRO-OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
----- Electronic Characteristics -----							
Logic Circuit Supply Voltage	VDD-VSS	--	2.4	2.8	3.5	V	
LCD Driving Voltage (FSTN)	VLCD	-20 °C	--		--	V	
		25 °C	9.8	10	10.2		
		70 °C	--		--		
Input Voltage	VIH	--	0.8VDD	--	VDD	V	
	VIL	--	-0	--	0.2 VDD	V	
Logic Supply Current	IDD	VDD=2.8V	--	0.23	0.45	mA	
----- Optical Characteristics (FSTN) -----							
Contrast	CR	25°C	--	8	--		Note 1
Rise Time	tr	25°C	--	200	--	ms	Note 2
Fall Time	tf	25°C	--	200	--	ms	
Viewing Angle Range	θ f	25°C & CR≥2	--	40	--	Deg.	Note 3
	θ b		--	35	--		
	θ l		--	40	--		
	θ r		--	40	--		
Frame Frequency	fF	25°C	--	70	--	Hz	

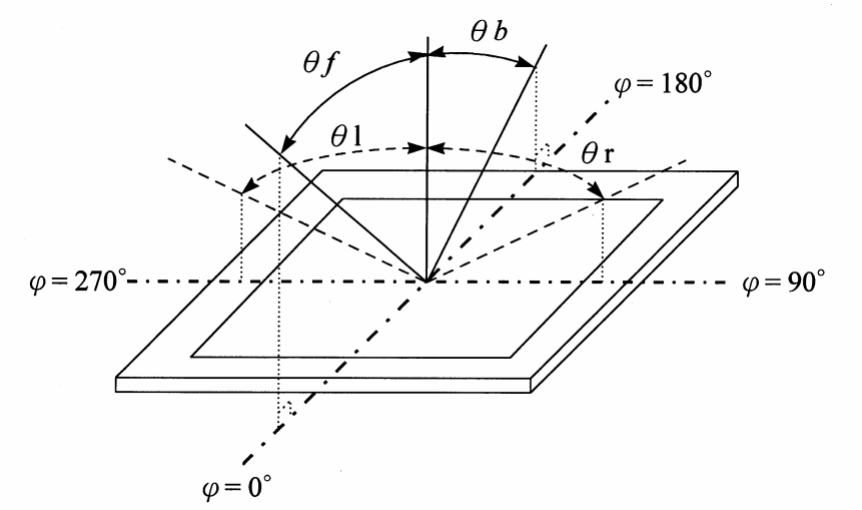
(NOTE 1) Contrast ratio :

CR = (Brightness in OFF state) / (Brightness in ON state)

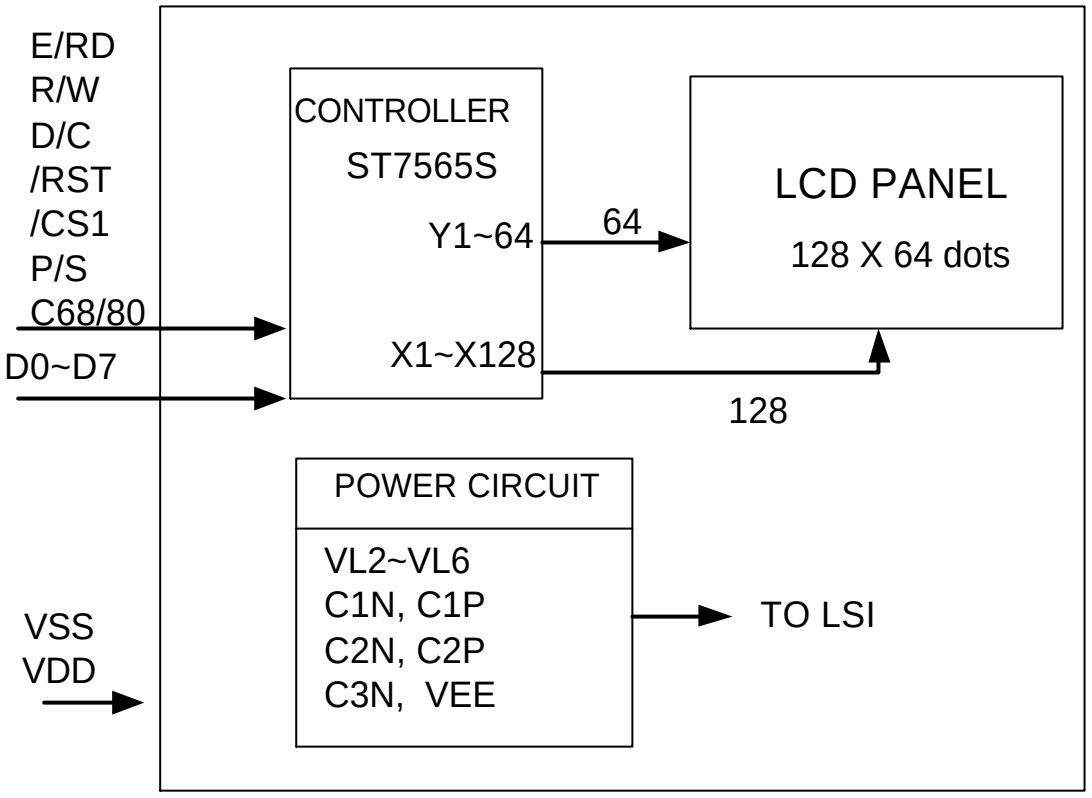
(NOTE 2) Response time :



(NOTE 3) Viewing angle



5 BLOCK DIAGRAM & POWER SUPPLY



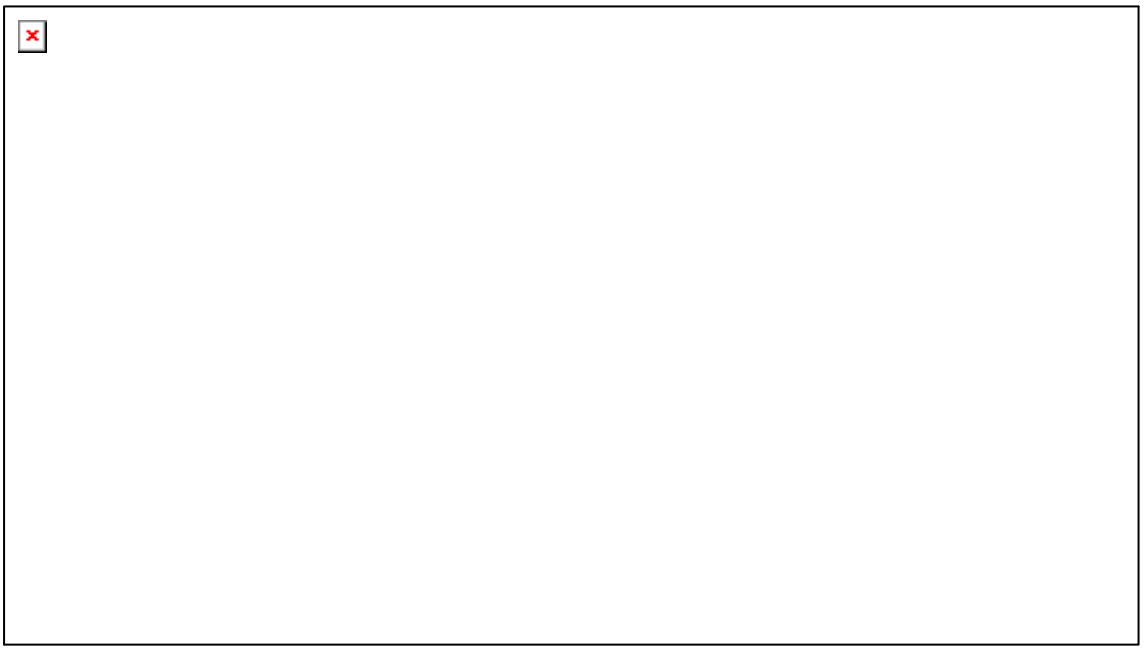
6 INTERFACE

No.	Symbol	Function	
1	NC	No connection	
2	NC	No connection	
3	VDD	Power supply for logic	
4	P/S	Parallel / serial data input select input "H": Parallel "L":Serial	
5	C68/80	Microprocessor Interface select input "H": 6800 Series "L": 8080 Series	
6	VSS	Ground (0V)	
7	V5	LCD driver supply voltage VDD (=V0) ≥ V1 ≥ V2 ≥ V3 ≥ V4 ≥ V5	
8	V4		
9	V3		
10	V2		
11	V1		
12	C2+	Used to voltage booster according to the boosting ratio.	
13	C2-		
14	C1-		
15	C1+		
16	C3-		
17	Vout	Voltage converter output	
18	VSS	Ground (0V)	
19	D7	8-bit data bus	Serial input data (SDA)
20	D6		Serial input clock (SCK)
21	D5		When the serial interface selected (P/S="L"), DB0~DB5 : high impedance
22	D4		
23	D3		
24	D2		
25	D1		
26	D0		
27	E/RD	Enable / Read execution control pin 68 series: "H": read/write data operation 80 series: "L": data read operation	
28	R/W	Read / Write execution control pin 68 series: "H": read "L": write 80 series: "L": data write operation	

29	D/C	Register select input pin RS=" H" : Indicates that D0 to D7 are Display Data RS=" L" : Indicates that D0 to D7 are Control Data
30	/RES	Reset signal at low
31	/CS1	Chip select signal (L: select; H: Non select)
32	NC	No connection
33	NC	No connection

7 TIMING CHARACTERISTICS

8080-SYSTEM



Parameter	Symbol	Min.	Typ.	Max.	Unit
8080 Series(VDD=2.7~ 4.5V)					
Address Hold Time(A0)	tAH8	0		-	ns
Address Setup Time(A0)	tAW8	0		-	ns
System Cycle Time((A0)	Tcyc8	300			ns
Control L Pulse Width(/WR)	tCCLW	60			ns
Control L Pulse Width(/RD)	tCCLR	120			ns
Control H Pulse Width(/WR)	tCCHW	60			ns
Control H Pulse Width(/RD)	tCCHR	60			ns
Data Setup Time(D0~7)	tDS8	40			ns
Address Hold Time	tDH8	15			ns
/RD access time	tACC8	-		140	ns
Output Disable Time	tOH8	10		100	ns

8 QUALITY AND RELIABILITY

8.1 TEST CONDITIONS

Tests should be conducted under the following conditions :

Ambient temperature : 25 ± 5°C

Humidity : 60 ± 25% RH.

8.2 SAMPLING PLAN

Sampling method shall be in accordance with MIL-STD-105E , level II, normal single sampling plan .

8.3 ACCEPTABLE QUALITY LEVEL

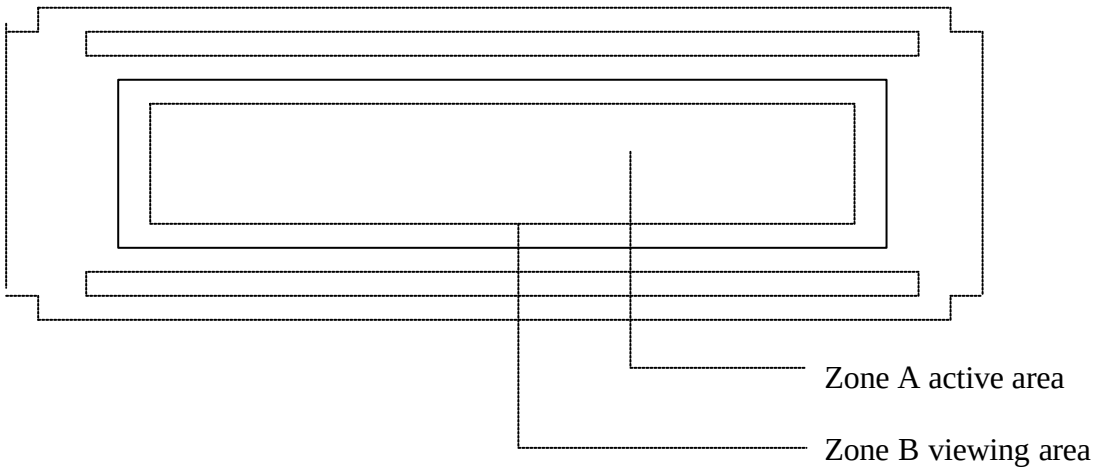
A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

8.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.

8.5 INSPECTION QUALITY CRITERIA

Item	Description of defects			Class of Defects	Acceptable level (%)
Function	Short circuit or Pattern cut			Major	0.65
Dimension	Deviation from drawings			Major	1.5
Black spots	Ave . dia . D	area A	area B	Minor	2.5
	D≤0.2	Disregard			
	0.2<D≤0.3	3	4		
	0.3<D≤0.4	2	3		
	0.4<D	0	1		
Black lines	Width W, Length L	A	B	Minor	2.5
	W≤0.03	disregard			
	0.03<W≤0.05	3	4		
	0.05<W≤0.07 , L≤3.0	1	1		
	See line criteria				
Bubbles in polarizer	Average diameter D 0.2 < D < 0.5 mm for N = 4 , D > 0.5 for N = 1			Minor	2.5
Color uniformity	Rainbow color or newton ring.			Minor	2.5
Glass Scratches	Obvious visible damage.			Minor	2.5
Contrast ratio	See note 1			Minor	2.5
Response time	See note 2			Minor	2.5
Viewing angle	See note 3			Minor	2.5



8.6 RELIABILITY

Test Item	Test Conditions	Note
	Extend Temp. type	
High Temperature Operation	70±3°C , t=96 hrs	
Low Temperature Operation	-20±3°C , t=96 hrs	
High Temperature Storage	80±3°C , t=96 hrs	1,2
Low Temperature Storage	-30±3°C , t=96 hrs	1,2
Thermal Shock Test	-30°C ~ 25°C ~ 80°C 30 m in. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2
Humidity Test	40 °C, Humidity 90%, 96 hrs	1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).

Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

9 HANDLING PRECAUTIONS

(1) A LCD module is a fragile item and should not be subjected to strong mechanical shocks.

(2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in color.

(3) Under no circumstances should the position of the bezel tabs or their shape be modified.

(4) Do not modify the display PCB in either shape or positioning of components.

(5) Do not modify or move location of the zebra or heat seal connectors.

(6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.

(7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.

(8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.

(9) Prior to initial power up input signals should not be applied.

(10) Protect the module against static electricity and observe appropriate anti-static precautions.

10 OUTLINE DIMENSION